

Customer No. 26857

CIL-10782 B

S-96281

OPTIMIZED CAPPING LAYERS FOR EUV MULTILAYERS

BY

Sasa Bajt (Slovenia)
1312 Melanie Way
Livermore, CA 94550

James A. Folta (USA)
2262 Hampton Road
Livermore, CA 94550

Eberhard A. Spiller (Germany)
60 Lakeside Road
Mt. Kisco, NY 10549

5

OPTIMIZED CAPPING LAYERS FOR EUV MULTILAYERS

This application is a continuation-in-part of U.S. Patent Application
Serial No. 09/898,833, titled "Optimized Capping Layers For EUV Multilayers"
filed July 3, 2001, incorporated herein by reference.

The United States Government has rights in this invention pursuant to
Contract No. W-7405-ENG-48 between the United States Department of Energy
and the University of California for the operation of Lawrence Livermore
National Laboratory.

BACKGROUND OF THE INVENTION

Field of the Invention

The present invention relates to capping layers for multilayer reflective
coatings used in extreme ultraviolet or soft x-ray lithography applications.

Description of Related Art

Extreme ultraviolet (EUV) and soft x-ray projection lithography make use of optical elements with highly reflective multilayer coatings. These multilayer coatings typically consist of alternating layers of molybdenum (Mo) and silicon (Si) or molybdenum and beryllium (Be). High EUV reflectivity is essential for lithography applications. A critical limitation to achieving the maximum theoretical peak reflectivity is the oxidation and corrosion of the top layers, which both increases the absorption and degrades the phase coherence of the reflection from these layers.

Although there have been numerous investigations of carbon-based, boron carbide-based, and silicon-based multilayer coatings for EUV mirrors, there has been little work on environmental effects (e.g., oxidation and corrosion) of these structures. Underwood et al. (Applied Optics 32:6985 (1993)) investigated the aging effects of Mo-Si multilayers by monitoring the decrease in reflectivity with time. Their experimental results showed a degradation of the Mo-Si multilayer reflectance caused by the oxidation of the topmost layer of molybdenum. Underwood et al. identified the oxidation of the molybdenum layer as a potential problem in soft x-ray projection lithography. The proposed solutions were to make silicon the topmost layer, to store the optical elements in an inert atmosphere or vacuum, or to remove the oxidized surface by sputtering

or chemical etching. Underwood et al. did not investigate the use of passivating layers.

Mo/Si multilayers with Mo as the top layer have the highest theoretically possible reflectivity; however, Mo is not stable in air and therefore Mo/Si multilayers for EUV optics are usually capped with a Si top layer with a loss in reflectivity of 1.3%. After exposure to air, this layer partly oxidizes and forms SiO₂ that absorbs EUV light and reduces the reflectance of the multilayer by about another 1-2 %. This reflectance of Si capped multilayers will remain unchanged for years if the multilayers are kept at room temperatures. See C. Montcalm, S. Bajt, P. B. Mirkarimi, E. Spiller, F. J. Weber, and J. A. Folta, in "Emerging Lithographic Technologies II", ed. Y. Vladimirovsky, SPIE Vol 3331, 42-51 (1998). However, in a working EUV lithography tool the coatings are exposed to EUV illumination in the presence of low pressure background gases including water, oxygen, and hydrocarbons. L. Klebanoff et al., M. Wedowski et al. references have shown that the reflectance of Si capped Mo/Si multilayers decreased as a function of EUV illumination dose and the amount of water vapor and other background gases in the system.

U.S. Patent No. 5,958,605, titled "Passivating Overcoat Bilayer For Multilayer Reflective Coatings For Extreme Ultraviolet Lithography", discloses a passivating overcoat bilayer that is used for multilayer reflective coatings for extreme ultraviolet (EUV) or soft x-ray applications to prevent oxidation and

corrosion of the multilayer coating, thereby improving the EUV optical performance. The overcoat bilayer comprises a layer of silicon or beryllium underneath at least one top layer of an elemental or a compound material that resists oxidation and corrosion. Materials for the top layer include carbon,
5 palladium, carbides, borides, nitrides, and oxides. The thicknesses of the two layers that make up the overcoat bilayer are optimized to produce the highest reflectance at the wavelength range of operation. Protective overcoat systems comprising three or more layers are also possible.

SUMMARY OF THE INVENTION

10 It is an object of the present invention to provide a passivating overcoat bilayer for a multilayer reflective coating designed for use in extreme ultraviolet or soft x-ray applications.

15 It is another object of the invention to provide a bottom overcoat layer that prevents diffusion of a top overcoat layer into the top layer of a multilayer reflective coating.

It is another object of the invention to provide a top overcoat layer made of material that resists oxidation and corrosion and protects a multilayer reflective coating from oxidation.

20 These and other objects will be apparent based on the disclosure herein.

The present invention is a passivating overcoat bilayer for multilayer reflective coatings for soft x-ray or extreme ultraviolet applications and the method for making such layers. These passivating layers are useful for reflective optical coatings for soft x-ray and extreme ultraviolet wavelengths in applications such as microscopy, astronomy, spectroscopy, laser research, laser cavities and optics, synchrotron optics, and projection lithography.

A passivating overcoat bilayer (also called a "capping" bilayer) is deposited on top of a multilayer coating to prevent oxidation and corrosion of the multilayer coating, thereby improving the EUV optical performance. The multilayer coating can comprise alternating layers of a variety of materials, such as molybdenum-silicon, molybdenum carbide-silicon, molybdenum-beryllium, and molybdenum carbide-beryllium. The passivating bilayer comprises a diffusion resistant layer underneath at least one top layer of an elemental material or compound that resists oxidation and corrosion. Oxidation resistant materials for the top layer (or layers) may include pure elements, such as Ru, Zr, Rh or Pd, and similar materials or compound materials. Diffusion resistant materials for the bottom layer include B_4C , Mo and carbon and similar materials or compound materials. The top layer and the bottom layer may each comprise a plurality of layers.

The thickness of each layer that makes up the overcoat bilayer is in the range of about 0.5 to 7 nanometers, and the thicknesses are selected to produce

the highest reflectance at the EUV wavelength range of operation. The thickness of the overcoat bilayer will typically be different from the thickness of the pairs of alternating layers in the underlying multilayer coating. The thickness of the two layers in the overcoat are individually optimized so as to provide sufficient chemical protection and to maximize EUV optical performance.

BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 shows passivating overcoat bilayer of the present invention on a multilayer reflective coating.

Figure 2 shows an embodiment that uses a diffusion barrier of Mo under a Ru layer.

Figure 3 shows optimization of the thicknesses of Ru and Mo to obtain the highest reflectances.

Figure 4A shows an embodiment that provides a diffusion barrier of B_4C under the Ru layer.

Figure 4B illustrates the replacement with B_4C of the top part of the last Si layer of the multilayer reflective coating.

Figure 5 shows the optimum B_4C barrier thickness is a tradeoff between reflectance and interdiffusion.

Figure 6 shows the reflectance as a function of wavelength of a Ru/B₄C/Si capping layer system and a Ru/Mo capping layer system where the Ru layers are 2.2 nm thick.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

The present invention is a passivating overcoat bilayer for a multilayer reflective coating and is shown schematically in Figure 1. The overcoat bilayer 10 is made up of a top layer 14, and a bottom layer 12. Top layer 14 comprises a material that resists corrosion and oxidation and protects the underlying layers from oxidation. The bottom layer 12 is deposited on a multilayer coating 16, which typically comprises alternating layers of an absorber material 18 and a spacer material 20. The multilayer coating 16 is deposited on a substrate 22. Bottom layer 12 comprises a material that prevents diffusion of the top layer 14 into the top layer 18 of the multilayer coating 16. The present invention contemplates including a plurality of components and layers within top layer 14 and/or bottom layer 12.

Ru is very stable against oxidation in the environment of a EUV camera. However, a loss in reflectance of 1%- 5% is observed over the standard reference coating. This loss is due to the diffusion of Ru and Si and the formation of ruthenium silicide. For a successful capping layer system, an additional layer that acts as diffusion barrier between the Ru and the underlying structure is

therefore needed. Other elements that can be substituted for Ru in the present invention include Zr, Rh and Pd and similar materials and compounds.

The embodiments discussed herein contain both the oxidation protection and the diffusion barrier. Both systems use a top layer of Ru as the protection against oxidation. Figure 2 shows an embodiment that uses a diffusion barrier 30 of Mo under the Ru layer 32 and on top of the last Si layer 34 in the first system. The molybdenum layer acts as the diffusion barrier between the Ru layer and the Si layer. Multilayers capped with 1.3 nm of Mo and between 0.6 nm and 2 nm of Ru have been produced. This embodiment has measured over 67% reflectance. Figure 3 shows optimization of the thicknesses of Ru and Mo to obtain the highest reflectances. Diffusion barrier 30 may be formed from other materials such as, e.g., carbon.

Figure 4A shows an embodiment that provides a diffusion barrier 40 of B_4C under the Ru layer 42 and on top of the last Si layer 44, which is on Mo layer 46. Ru/ B_4C multilayers form very smooth and compositionally abrupt interfaces. Thermal annealing at 100° and 250° C produced no measurable change in the reflectance. A theoretical calculation shows a 2-3% reflectance loss if the last Si layer is replaced with B_4C due to the less favorable optical properties of B_4C in the EUV energy range. Experimental data support this prediction. However, this loss can be greatly reduced by replacing only the top part of the last Si layer with B_4C , as shown in Figure 4A. Experiments exploring how far the

thickness of B_4C can be reduced have shown that the boron carbide layer must be at least 0.6 nm or thicker. The expected reflectance loss is only 0.6% if B_4C replaces 1/3 of the last Si layer. In this case boron carbide is about 1.3 nm thick. The experimental data in Figure 5 shows that the optimum B_4C barrier thickness is a tradeoff between reflectance and interdiffusion. Figure 6 shows the reflectance as a function of wavelength of a Ru/ B_4C /Si capping layer system and a Ru/Mo capping layer system where the Ru layers are 2.2 nm thick. Figure 4B shows an embodiment where the top Si layer of a Si/Mo multilayer structure has been entirely replaced with a B_4C layer 50. In the figure, the multilayer structure is formed of alternating layers of Mo (52) and Si (54). It can be seen that the thickness 56 of one pair of alternating layers of the multilayer structure is the same as the combined thickness 58 of the Mo layer 54 and the B_4C layer 50. Ru layer 60 is shown on top of the B_4C layer 50. Diffusion barrier 50 may be formed from other materials such as, e.g., carbon.

Referring again to Figure 1, a multilayer coating 16 that is designed for applications in extreme ultraviolet (EUV) lithography is typically made of a periodic stack of 40-100 alternating layers of molybdenum (Mo) and silicon (Si), or molybdenum and beryllium (Be). Although other structures are possible (e.g., non-periodic stacks, multilayer stacks with other materials or with more than two materials), the combinations of Mo and Si in one case and Mo and Be in another case, exhibit unusually high normal incidence reflectivity (at least 65%)

in the EUV wavelength region (i.e., less than about 15 nanometers). When Mo and Si or Mo and Be are used for the multilayer stack, the topmost layer of the multilayer coating 16 would typically be molybdenum (the absorber material). However, since molybdenum is not stable in air, the additional overcoat bilayer is needed. It should be recognized that the Mo in the Mo/Si multilayer structures could be replaced with an absorber layer comprising another material. For example, the Mo can be replaced with molybdenum carbide or Mo_2C . It should also be appreciated that the Mo in a Mo/Be multilayer structure can be replaced by MoRu.

In two of the embodiments discussed, the bottom layer 12 of the overcoat bilayer 10 is made up of either B_4C or Mo. The top layer 14 is deposited or grown on the bottom layer 12 and comprises Ru, which is a material that resists oxidation and corrosion, and has a low chemical reactivity with common atmospheric gas species such as oxygen, nitrogen, and water vapor. For purposes of this disclosure, "deposition" of the top layer is intended to encompass the concepts of both "depositing" and "growing". This top layer 14 serves to chemically passivate and protect the underlying multilayer coating 16 and to preserve the high reflectance of the coating.

The passivating overcoat can be grown using a vapor phase deposition technique (e.g., sputtering). This method can be incorporated into the multilayer deposition system (e.g., magnetron sputtering with argon plasma) so that the

multilayer stack can be encapsulated in situ without exposure to the atmosphere. Alternatively, the overcoat can be grown by chemical reaction.

5 The thicknesses of the bottom layer 12 and the top layer 14 of the overcoat bilayer 10 are chosen to produce the highest reflectance and offer high oxidation resistance at the EUV wavelength of operation, in a similar manner to how the thicknesses of both layers in the underlying periodic multilayer stack 16 were determined.

10 As discussed in U.S Patent No. 3,887,261, titled "Low-loss reflection coatings using absorbing materials", the best reflecting multilayer geometry is usually a quarter-wave stack, where the optical thickness of each layer is equal to a quarter of the wavelength of interest at normal incidence. (The optical thickness of a layer is the product of the geometrical or metric thickness and the refractive index of the material.) In the quarter-wave stack, the beams reflected from each interface are in phase and add constructively. This design is ideal when both materials in the stack are non-absorbing, and still remains the best when the extinction coefficients of the two materials are similar. However, when the absorption of one of the two materials is larger, as in the case of EUV multilayer mirrors, the design of the stack must be modified to reduce the overall absorption. The thickness of the absorber is reduced, while the period thickness 20 24 is kept constant. Therefore, thicknesses are determined by the trade-off between maximizing the constructive interference of the beams reflected at each

